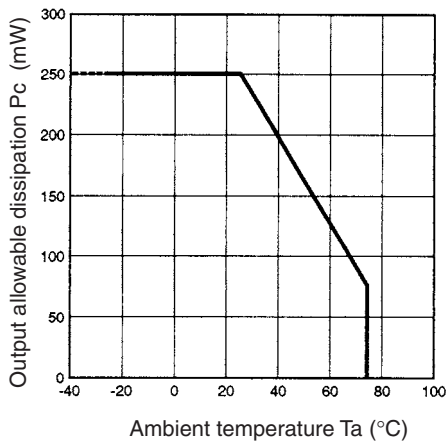
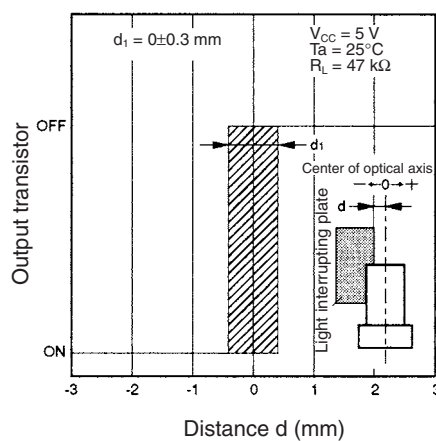


■ Engineering Data

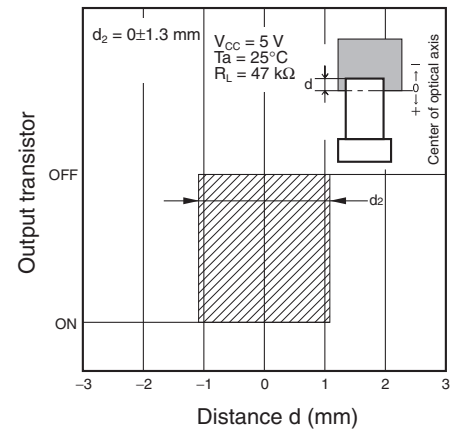
Output Allowable Dissipation vs. Ambient Temperature Characteristics



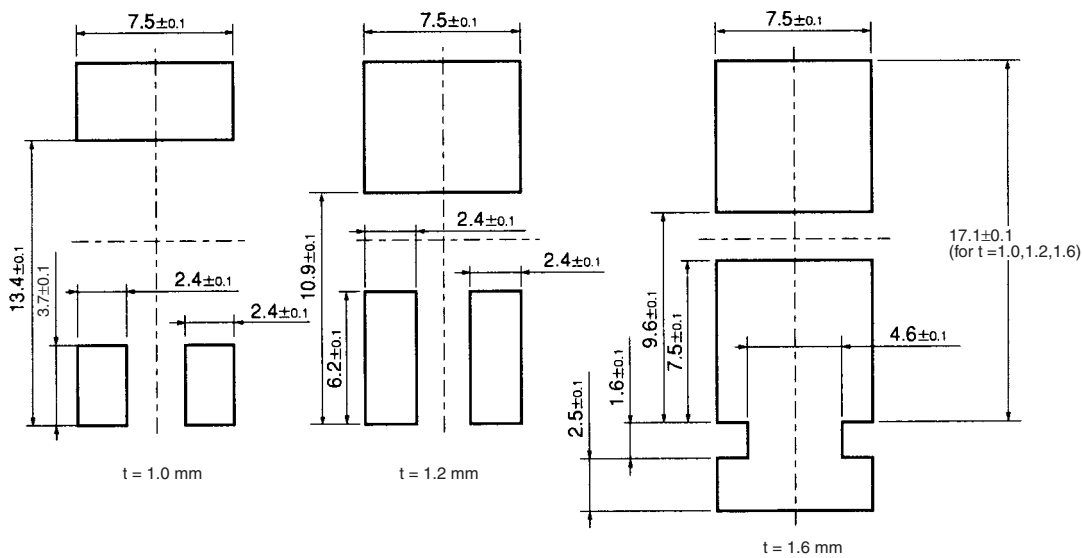
Sensing Position Characteristics (Typical)



Sensing Position Characteristics (Typical)



■ Recommended Mounting Holes



- When mounting the Photomicrosensor to a panel with a hole opened by pressing, make sure that the hole has no burrs. The mounting strength of the Photomicrosensor will decrease if the hole has burrs.
- When mounting the Photomicrosensor to a panel with a hole opened by pressing, be sure to mount the Photomicrosensor on the pressing side of the panel.
- The mounting strength of the Photomicrosensor will increase if the Photomicrosensor is mounted to a panel with a hole that is only a little larger than the size of the Photomicrosensor, in which case, however, it will be difficult to mount the Photomicrosensor to the panel. The mounting strength of the Photomicrosensor will decrease if the Photomicrosensor is mounted to a panel with a hole that is comparatively larger than the size of the Photomicrosensor, in which case, however, it will be easy to mount the Photomicrosensor to the panel. When mounting the Photomicrosensor to a panel, open an appropriate hole for the Photomicrosensor according to the application.
- After mounting the Photomicrosensor to any panel, make sure that the Photomicrosensor does not wobble.
- When mounting the Photomicrosensor to a molding with a hole, make sure that the edges of the hole are sharp enough, otherwise the Photomicrosensor may fall out.